



D5V0F1U2LP3Q

LOW CAPACITANCE UNIDIRECTIONAL TVS DIODE

Features

- Ultra-Small, Low Profile Leadless Surface Mount Package (0.6 x 0.3 x 0.3mm)
- IEC 61000-4-2 (ESD): Air ±20kV, Contact ±15kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance of 0.5pF Typical
- Typically Used at High Speed Ports such as USB 3.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DIODES™ D5V0F1U2LP3Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: X3-DFN0603-2
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin over Copper Leadframe, Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.0002 grams (Approximate)



Ordering Information (Note 4)

Part Number	Baakaga	Morking	Bool Size (inches)	Tape Width (mm)	Packing		
Part Number	Part Number Package Marking Reel Size (inches	Reel Size (inches)	rape width (mm)	Qty.	Carrier		
D5V0F1U2LP3Q-7	X3-DFN0603-2	TK	7	8	10,000	Tape & Reel	

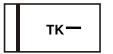
No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



TK = Product Type Marking Code = Assembled in Chengdu Bar Denotes Pin 1 or Cathode Side



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	IPP	1.5	А	8/20µs, Per Figure 3
ESD Protection – Contact Discharge	VESD_Contact	±15	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	VESD_Air	±20	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	Reja	500	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified)

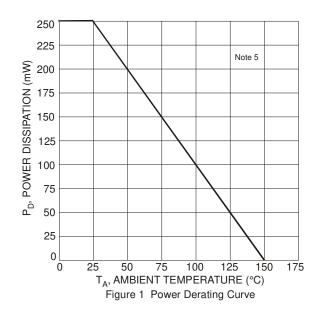
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	VRWM	—	—	5.5	V	—
Reverse Current (Note 6)	IR	_	_	100	nA	V _R = 5.0V
Reverse Breakdown Voltage	V _{BR}	6.0	_	_	V	I _R = 1mA
Reverse Clamping Voltage, Positive Transients (Note 7)	Vcl	_	10	12	V	IPP = 1A, t _p = 8/20µs
Dynamic Resistance	Rdyn	—	1.4	_	Ω	I _R = 1A, t _p = 8/20µs
Canacitanaa (Nota 9)	<u> </u>	_	0.4	0.65	pF	V _R = 2.5V, f = 1MHz
Capacitance (Note 8)	Ст	_	0.5	_	pF	$V_R = 0V, f = 1MHz$

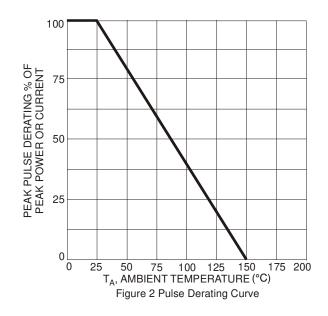
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

6. Short duration pulse test used to minimize self-heating effect.

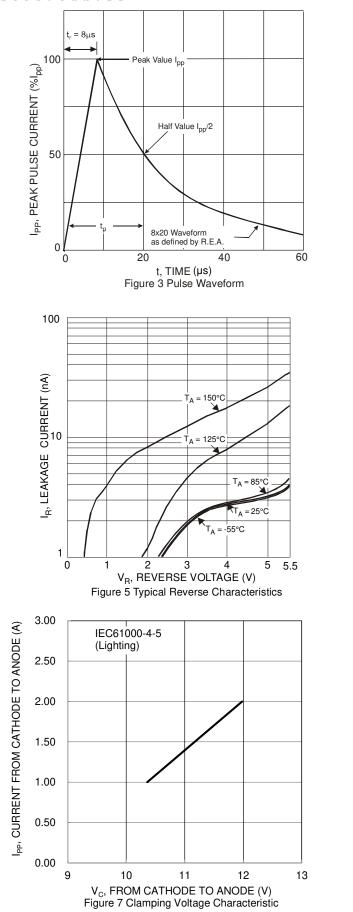
7. Clamping voltage value is based on an 8 x 20 μ s peak pulse current (I_{pp}) waveform.

8. Measured from any I/O to GND.

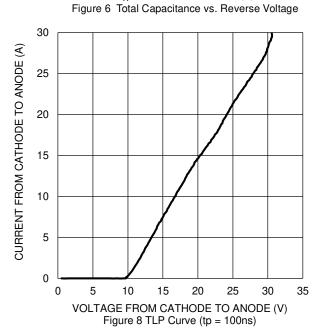








T_A = 150° 125°C = 85°C Τ_A = 25°C $T_A = -55^{\circ}C$ 400 500 600 700 800 900 1000 1100 V_F, INSTANTANEOUS FORWARD VOLTAGE (mV) Figure 4 Typical Forward Characteristics f = 1MHz Note 8



1.5 2 2.5 3 3.5 4 4 V_R, REVERSE VOLTAGE (V)

4.5 5 5.5

Note: 8. Measured from any I/O to GND. D5V0F1U2LP3Q Document number: DS42344 Rev. 1 - 2

D5V0F1U2LP3Q

1000

100

10

1

0.1

0.01

0.6

0.55

101AL CAPACITANCE (pF) 0.4 0.4 0.3 0.3 0.3 0.3 0.3 0.3 0.3 0.3

Ĵ 0.2

0.15

0.1

0 0.5 1

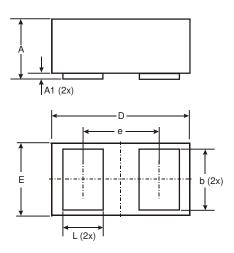
300

 $I_{\rm F},$ INSTANTANEOUS FORWARD CURRENT (mA)



Package Outline Dimensions

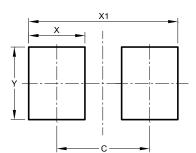
Please see http://www.diodes.com/package-outlines.html for the latest version.



X3-DFN0603-2					
Dim	Min	Max	Тур		
Α	0.27	0.35	0.30		
A1	0.00	0.03	0.02		
b	0.19	0.29	0.24		
D	0.595	0.645	0.62		
E	0.295	0.345	0.32		
е	-	-	0.355		
Ĺ	0.14	0.24	0.19		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



X3-DFN0603-2

Dimensions	Value (in mm)
С	0.380
Х	0.230
X1	0.610
Y	0.300

X3-DFN0603-2



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